

INFORMATION CITED BY APPLICANTS THAT MAY BE MATERIAL TO THE
PROSECUTION OF THE SUBJECT APPLICATION

Applicants: Jee-Soo Mok, Jang-Kyu Kang, and Attorney Docket No. LEPA121687
Chang-Hyun Nam

Title: METHOD OF FORMING SOLDER RESIST PATTERN

U.S. PATENT DOCUMENT

*Examiner Initials	Cite No.	Document No.	Kind Code	Date (mm/dd/yyyy)	Name
	U1	5,324,535		06/28/1994	Ishido

FOREIGN PATENT DOCUMENTS

*Examiner Initial	Cite No.	Document No.	Kind Code	Publication Date (mm/dd/yyyy)	Country	English Abstract Provided	Translation Provided
None							

OTHER INFORMATION
(Including Author, Title, Date, Pertinent Pages, Etc.)

*Examiner Initial	Cite No.
None	

Examiner _____ Date Considered _____

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JEN:hjd